

DHG40C600HB

preliminary

Sonic Fast Recovery Diode

600 V V_{RRM}

I_{FAV} 20 A

40 ns

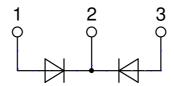
High Performance Fast Recovery Diode Low Loss and Soft Recovery Common Cathode

Part number

DHG40C600HB



Backside: cathode



Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low Irm-values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low Irm reduces:
- Power dissipation within the diode
- Turn-on loss in the commutating switch

Applications:

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

Package: TO-247

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

Terms _Conditions of usage:

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact your local sales office.

Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact your local sales office.

Should you intend to use the product in aviation, in health or life endangering or life support applications, please notify. For any such application we urgently recommend

to perform joint risk and quality assessments;
the conclusion of quality agreements;

- to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

IXYS reserves the right to change limits, conditions and dimensions.

Data according to IEC 60747 and per semiconductor unless otherwise specified

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Fast Diode				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V _{RSM}	max. non-repetitive reverse blocki	ng voltage	$T_{VJ} = 25^{\circ}C$			600	V
V _{RRM}	max. repetitive reverse blocking v	oltage	$T_{VJ} = 25^{\circ}C$			600	V
IR	reverse current, drain current	$V_R = 600 \text{ V}$	$T_{VJ} = 25^{\circ}C$			25	μΑ
		$V_R = 600 \text{ V}$	$T_{VJ} = 125^{\circ}C$			1.5	mΑ
V _F	forward voltage drop	I _F = 20 A	$T_{VJ} = 25^{\circ}C$			2.24	٧
		$I_F = 40 \text{ A}$				3.15	V
		I _F = 20 A	T _{vJ} = 125°C			2.19	V
		$I_F = 40 \text{ A}$				3.21	V
I _{FAV}	average forward current	T _c = 95°C	T _{vJ} = 150°C			20	Α
		rectangular d = 0.5					
V _{F0}	threshold voltage		T _{vJ} = 150°C			1.12	V
r _F	slope resistance } for power lo	ss calculation only				49	mΩ
R _{thJC}	thermal resistance junction to case	9				0.9	K/W
R _{thCH}	thermal resistance case to heatsir	nk			0.25		K/W
P _{tot}	total power dissipation		$T_C = 25^{\circ}C$			140	W
I _{FSM}	max. forward surge current	$t = 10 \text{ ms}$; (50 Hz), sine; $V_R = 0 \text{ V}$	$T_{VJ} = 45^{\circ}C$			150	Α
CJ	junction capacitance	$V_R = 400 \text{V}$ f = 1 MHz	$T_{VJ} = 25^{\circ}C$		12		pF
I _{RM}	max. reverse recovery current		$T_{VJ} = 25 ^{\circ}\text{C}$		8		Α
		$I_F = 20 \text{ A}; V_R = 300 \text{ V}$	T _{vJ} = 125°C		12		Α
t _{rr}	reverse recovery time	$I_F = 20 \text{ A}; V_R = 300 \text{ V}$ $-\text{di}_F / \text{dt} = 450 \text{ A} / \mu \text{s}$	$T_{VJ} = 25 ^{\circ}\text{C}$		40		ns
		,	T _{vJ} = 125°C		60		ns



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Package TO-247			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I _{RMS}	RMS current	per terminal 1)			70	Α
T _{VJ}	virtual junction temperature		-55		150	°C
T _{op}	operation temperature		-55		125	°C
T _{stg}	storage temperature		-55		150	°C
Weight				6		g
M _D	mounting torque		0.8		1.2	Nm
F _c	mounting force with clip		20		120	Ν

Product Marking IXYS **تا** ∻ Logo →XXXXXXXXX Part No. Assembly Line → Zyyww Assembly Code

Part description

D = Diode

H = Sonic Fast Recovery Diode

G = extreme fast

40 = Current Rating [A]

C = Common Cathode

600 = Reverse Voltage [V] HB = TO-247AD (3)

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DHG40C600HB	DHG40C600HB	Tube	30	505145

Similar Part	Package	Voltage class
DHG40C600PB	TO-220AB (3)	600

Equivalent Circuits for Simulation			* on die level	T _{vJ} = 150 °C
$I \rightarrow V_0$)— <u>R</u> o	Fast Diode		
V _{0 max}	threshold voltage	1.12		V
$R_{0 \text{ max}}$	slope resistance *	46		$m\Omega$

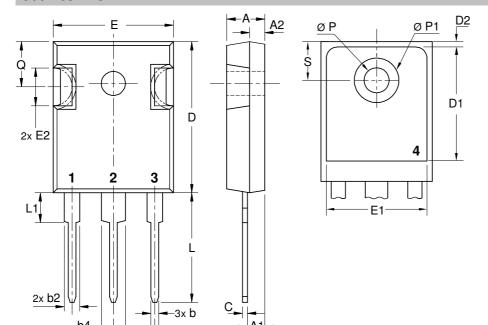




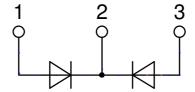
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Outlines TO-247

2xe



Sym.	Inches		Millimeter		
	min.	max.	min.	max.	
Α	0.185	0.209	4.70	5.30	
A1	0.087	0.102	2.21	2.59	
A2	0.059	0.098	1.50	2.49	
D	0.819	0.845	20.79	21.45	
E	0.610	0.640	15.48	16.24	
E2	0.170	0.216	4.31	5.48	
е	0.215	BSC	5.46	BSC	
L	0.780	0.800	19.80	20.30	
L1	-	0.177	-	4.49	
ØΡ	0.140	0.144	3.55	3.65	
Q	0.212	0.244	5.38	6.19	
S	0.242	BSC	6.14 BSC		
b	0.039	0.055	0.99	1.40	
b2	0.065	0.094	1.65	2.39	
b4	0.102	0.135	2.59	3.43	
С	0.015	0.035	0.38	0.89	
D1	0.515	-	13.07	-	
D2	0.020	0.053	0.51	1.35	
E1	0.530	-	13.45	-	
Ø P1	-	0.29	-	7.39	



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Fast Diode

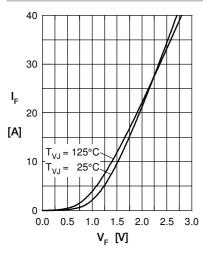


Fig. 1 Typ. Forward current versus $V_{\rm F}$

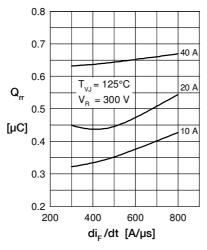


Fig. 2 Typ. reverse recov. charge Q_{rr} versus di/dt

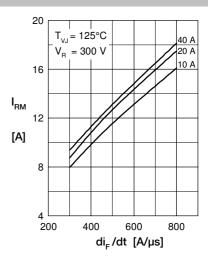


Fig. 3 Typ. peak reverse current $I_{\rm RM}$ versus di/dt

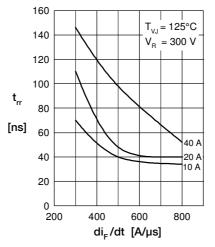
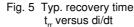
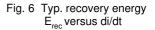


Fig. 4 Dynamic parameters Q_{rr} , I_{RM} versus T_{VJ}





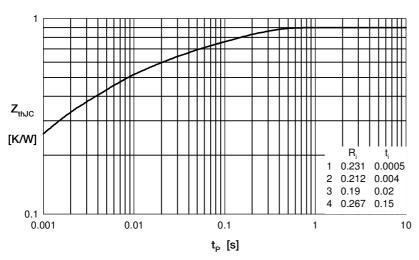


Fig. 7 Typ. transient thermal impedance junction to case

Mouser Electronics

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